### 1.4A, Inductor Built-in Step-up DC/DC Converters

## ■GENERAL DESCRIPTION

XCL104/XCL105 series are synchronous step-up DC/DC converters which integrates an inductor with a $0.17 \Omega$ Nch driver FET and a $0.23 \Omega$ synchronous Pch switching FET built-in.
The series are able to start operation from an input voltage of 0.9 V , suitable for equipment using single Alkaline battery or Nickel metal hydride battery.
The output voltage can be set from 1.8 V to 5.5 V in steps of 0.1 V .
During the devices enter stand-by mode, A/D/G/J types prevent the application malfunction by CL Discharge function which can quickly discharge the electric charge at the output capacitor ( $\mathrm{C}_{\mathrm{L}}$ ). $\mathrm{B} / \mathrm{E} / \mathrm{H} / \mathrm{K}$ types are able to allows the drive of subsequent devices by the bypass function which maintain continuity between the input and output. C/F/M/L types are able to connect in parallel with other power supplies by Load Disconnection function which breaks continuity between the input and output

## -APPLICATIONS

- Portable equipment
- Beauty \& health equipment
- Wearable devices
- Game \& Hobby
-PC Peripherals
-Devices with 1~3 Alkaline,
1~3 Nickel Hydride,
1 Lithium and 1 Li-ion


## FEATURES

| Input Voltage Range | : 0.65V ~ 6.0V (Operation start voltage : 0.9V) |
| :---: | :---: |
| Fixed Output Voltage | : $1.8 \mathrm{~V} \sim 5.5 \mathrm{~V}$ (A,B,C type) |
|  | 2.2V ~ 5.5V (except A, B, C type) |
| Oscillation Frequency | 1.2MHz |
| Output Current | $: 710 \mathrm{~mA}$ @ $\mathrm{V}_{\text {out }}=5.0 \mathrm{~V}, \mathrm{~V}_{\text {IN }}=3.3 \mathrm{~V}$ |
|  | $420 \mathrm{~mA} @ \mathrm{~V}_{\text {OUt }}=3.3 \mathrm{~V}, \mathrm{~V}_{\text {IN }}=1.8 \mathrm{~V}$ |
| Control Mode Selection | : PWM (XCL104) |
|  | PWM/PFM (XCL105) |
| Load Transient Response | $\begin{gathered} : 120 \mathrm{mV} @ \mathrm{~V}_{\text {out }}=3.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{IN}}=1.8 \mathrm{~V}, \mathrm{fosc}=1.2 \mathrm{MHz} \\ \text { lout }^{\text {lo }}=1 \mathrm{~mA} \rightarrow 200 \mathrm{~mA}(\mathrm{tr}=5 \mu \mathrm{~s}) \end{gathered}$ |
| Protection Function | Thermal shutdown |
|  | Current limit |
|  | Integral latch method (D/E/F/J/K/L types) |
|  | Short circuit protection (D/E/F/J/K/L types) |
|  | UVLO (G/H/M/J/K/L types) |
| Functions | Soft-start |
|  | Load Disconnection (A/C/D/F/G/M/J/L types) |
|  | $C_{L}$ Auto Discharge (A/D/G/J types) |
|  | Bypass Switch (XCL105 B/E/H/K types) |
| Output Capacitor | Ceramic Capacitor |
| Operating Ambient Temperature | $-40^{\circ} \mathrm{C} \sim 105^{\circ} \mathrm{C}$ |
| Package | DFN3030-10B (3.0x3.0x1.7mm) |
| Environmentally Friendly | EU RoHS Compliant, Pb Free |

## -TYPICAL APPLICATIONS CIRCUIT



## TYPICAL PERFORMANCE

 CHARACTERISTICS$V_{\text {OUT(T) }}=3.3 \mathrm{~V}$
$\mathrm{C}_{\mathrm{N}}=10 \mathrm{~F}($ GRM188D71A106MA73)
$\mathrm{C}_{\mathrm{L}}=30 \mu \mathrm{~F}(\mathrm{GRM} 188 \mathrm{D} 71 \mathrm{~A} 106 \mathrm{MA} 73 \times 3)$


## XCL104/XCL105 Series

## BLOCK DIAGRAM

## - XCL104/XCL105 A/D/G/J types



* Diodes inside the circuits are ESD protection diodes and parasitic diodes.

XCL104 series chooses only PWM control.
UVLO / short circuit protection / integral latch can be selected according to the types.

- XCL105 B/E/H/K types

* Diodes inside the circuits are ESD protection diodes and parasitic diodes. UVLO / short circuit protection / integral latch can be selected according to the types.


## BLOCK DIAGRAM

## - XCL 105 C/F/M/L types



* Diodes inside the circuits are ESD protection diodes and parasitic diodes. UVLO / short circuit protection / integral latch can be selected according to the types.


## XCL104/XCL105 Series

## PRODUCT CLASSIFICATION

1. Standard product

## - Ordering Information

XCL104(1)(2)(3)(5)(6)-7) : PWM Control

| DESIGNATOR | ITEM | SYMBOL | DESCRIPTION |
| :---: | :---: | :---: | :---: |
| (1) | Type | A | Refer to Selection Guide |
|  |  | D |  |
| (2)(3) | Output Voltage <br> (A Type) | $18 \sim 55$ | Output Voltage : e.g. Vout $=1.8 \mathrm{~V} \Rightarrow(2)=1$, (3) $=8$ Output Voltage Range: $1.8 \mathrm{~V} \sim 5.5 \mathrm{~V}$ ( 0.1 V increments) |
|  | Output Voltage (D Type) | $22 \sim 55$ | Output Voltage : e.g. $\mathrm{V}_{\text {out }}=2.5 \mathrm{~V} \Rightarrow$ (2) $=2$, (3) $=5$ Output Voltage Range: $2.2 \mathrm{~V} \sim 5.5 \mathrm{~V}$ ( 0.1 V increments) |
| (4) | Oscillation Frequency | 1 | 1.2 MHz |
| (5)(6)-(7) ${ }^{(+1)}$ | Packages (Order Unit) | H2-G | DFN3030-10B (3,000pcs/Reel) |

${ }^{(* 1)}$ The "-G" suffix indicates that the products are Halogen and Antimony free as well as being fully EU RoHS compliant.

## Selection Guide

| TYPE | Purpose | UVLO | CL Discharge | Current Limit | Short Protection | Stand-by Options at $\mathrm{EN}=$ " L " |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| A | Load Disconnection | - | Yes | Yes (Without latch) | - | Complete Output Disconnect |
| D |  |  |  | Yes <br> (With integral latch) | Yes |  |

## - Ordering Information

XCL105(1)(2)(3)(4)5(6)-7): PWM/PFM automatic switching control

| DESIGNATOR | ITEM | SYMBOL | DESCRIPTION |
| :---: | :---: | :---: | :---: |
| (1) | Type | A | Refer to Selection Guide |
|  |  | B |  |
|  |  | C |  |
|  |  | D |  |
| (2)(3) | Output Voltage (A/B/C Type) | $18 \sim 55$ | Output Voltage : e.g. Vout $=1.8 \mathrm{~V} \Rightarrow$ (2) $=1$, (3) $=8$ <br> Output Voltage Range: $1.8 \mathrm{~V} \sim 5.5 \mathrm{~V}$ ( 0.1 V increments) |
|  | Output Voltage (D Type) | $22 \sim 55$ | Output Voltage : e.g. Vout $=2.5 \mathrm{~V} \Rightarrow$ (2) $=2$, (3) $=5$ Output Voltage Range: $2.2 \mathrm{~V} \sim 5.5 \mathrm{~V}$ ( 0.1 V increments) |
| (4) | Oscillation Frequency | 1 | 1.2 MHz |
| (5)(6)-(7) ${ }^{(1)}$ | Packages (Order Unit) | H2-G | DFN3030-10B (3,000pcs/Reel) |

${ }^{(11)}$ The "-G" suffix indicates that the products are Halogen and Antimony free as well as being fully EU RoHS compliant.

## Selection Guide

| TYPE | Purpose | UVLO | $\begin{array}{c}\text { CL } \\ \text { Discharge }\end{array}$ | $\begin{array}{c}\text { Current } \\ \text { Limit }\end{array}$ | $\begin{array}{c}\text { Short } \\ \text { Protection }\end{array}$ | $\begin{array}{c}\text { Stand-by Options } \\ \text { at EN="L" }\end{array}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| A | Load Disconnection | - | Yes | $\begin{array}{c}\text { Yes } \\ \text { (Without latch) }\end{array}$ | - | $\begin{array}{c}\text { Complete }\end{array}$ |
|  | $\begin{array}{c}\text { Yes } \\ \text { (With integral latch) }\end{array}$ | Yes |  |  |  |  |$\}$

## PRODUCT CLASSIFICATION

2. Custom product ${ }^{\left({ }^{*} 1\right)}$
${ }^{(* 1)}$ Please contact our sales representative if you wish to select a custom product.

## -Ordering Information

XCL104(1)(2)(4)(5)(6)-7) : PWM Control

| DESIGNATOR | ITEM | SYMBOL | DESCRIPTION |
| :---: | :---: | :---: | :---: |
| (1) | Type | G | Refer to Selection Guide |
|  |  | $J$ |  |
| (2)(3) | Output Voltage (G/J Type) | $22 \sim 55$ | Output Voltage : e.g. Vout $=2.5 \mathrm{~V} \Rightarrow(2)=2$, (3) $=5$ Output Voltage Range: $2.2 \mathrm{~V} \sim 5.5 \mathrm{~V}$ ( 0.1 V increments) |
| (4) | Oscillation Frequency | 1 | 1.2 MHz |
| (5)(6)-(7) ${ }^{(2)}$ | Packages (Order Unit) | H2-G | DFN3030-10B (3,000pcs/Reel) |

${ }^{\left({ }^{11}\right)}$ The "-G" suffix indicates that the products are Halogen and Antimony free as well as being fully EU RoHS compliant.

## Selection Guide

| TYPE | Purpose | UVLO | $C_{L}$ <br> Discharge | Current Limit | Short Protection | Stand-by Options at EN="L" |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| G | Load Disconnection | Yes | Yes | Yes (Without latch) | - | Complete Output Disconnect |
| J |  |  |  | Yes <br> (With integral latch) | Yes |  |

## XCL104/XCL105 Series

## PRODUCT CLASSIFICATION

2. Custom product ${ }^{\left({ }^{* 1}\right)}$ (Continued)
${ }^{(* 1)}$ Please contact our sales representative if you wish to select a custom product.

## -Ordering Information

XCL105(1)(3)4(5)6-7) : PWM/PFM automatic switching control

| DESIGNATOR | ITEM | SYMBOL | DESCRIPTION |
| :---: | :---: | :---: | :---: |
| (1) | Type | E | Refer to Selection Guide |
|  |  | F |  |
|  |  | G |  |
|  |  | H |  |
|  |  | J |  |
|  |  | K |  |
|  |  | L |  |
|  |  | M |  |
| (2)(3) | Output Voltage (E/F/G/H/M/J/K/L Type) | $22 \sim 55$ | Output Voltage : e.g. Vout=2.5V $\Rightarrow$ (2) $=2$, (3) $=5$ Output Voltage Range: $2.2 \mathrm{~V} \sim 5.5 \mathrm{~V}$ ( 0.1 V increments) |
| (4) | Oscillation Frequency | 1 | 1.2 MHz |
| (5)(6)-(7) ${ }^{(2)}$ | Packages (Order Unit) | H2-G | DFN3030-10B (3,000pcs/Reel) |

${ }^{* 11}$ The "-G" suffix indicates that the products are Halogen and Antimony free as well as being fully EU RoHS compliant.

Selection Guide

| TYPE | Purpose | UVLO | CL Discharge | Current Limit | Short Protection | Stand-by Options at $\mathrm{EN}=$ " L " |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| G | Load Disconnection | Yes | Yes | Yes (Without latch) | - | Complete Output Disconnect |
| J |  |  |  | Yes (With integral latch) | Yes |  |
| E | Bypass Mode at $\mathrm{EN}=$ " L " | - | - | Yes (With integral latch) | Yes | Input-to-Output Bypass |
| H |  | Yes |  | Yes <br> (Without latch) | - |  |
| K |  |  |  | Yes (With integral latch) | Yes |  |
| F | Vout OR Connection | - | - | Yes (With integral latch) | Yes | Complete Output Disconnect |
| M |  | Yes |  | Yes (Without latch) | - |  |
| L |  |  |  | Yes <br> (With integral latch) | Yes |  |

## PIN CONFIGURATION



PIN ASSIGNMENT

| PIN NUMBER | PIN NAME | FUNCTIONS |
| :---: | :---: | :---: |
| 1 | Vout | Output Voltage |
| 2 | AGND | Analog Ground |
| 3 | NC | No Connection |
| 4 | VIN | Power Input |
| 5 | EN | Enable |
| 6 | NC | No Connection |
| 7 | PGND | Power Ground |
| 8 | Lx | Switching |
| 9 | L1 | Inductor Electrodes |
| 10 | L2 | Inductor Electrodes |
| 11 | EP | Exposed thermal pad. |

## FUNCTION CHART

| PIN NAME | SIGNAL | STATUS |
| :---: | :---: | :---: |
| EN | L | Stand-by |
|  | H | Active |
|  | OPEN | Undefined State ${ }^{(* 1)}$ |

${ }^{(* 1)}$ Do not leave the EN pin open.

## ABSOLUTE MAXIMUM RATINGS

| PARAMETER | SYMBOL | RATINGS | UNITS |
| :---: | :---: | :---: | :---: |
| Vin Pin Voltage | VIN | -0.3 | V |
| Lx Pin Voltage | VLx | -0.3 ~ 7.0 | V |
| Vout Pin Voltage | Vout | -0.3 ~ 7.0 | V |
| EN Pin Voltage | Ven | -0.3 | V |
| Power Dissipation $\left(\mathrm{Ta}=25^{\circ} \mathrm{C}\right)$ | Pd | 1950 (JESD51-7 board) ${ }^{(* 1)}$ | mW |
| Junction Temperature | Tj | -40~125 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature | Tstg | -55 ~ 125 | ${ }^{\circ} \mathrm{C}$ |

GND(AGND,PGND) are standard voltage for all of the voltages.
${ }^{\left({ }^{* 1)}\right)}$ The power dissipation figure shown above is based upon PCB mounted and it is for reference only.
Please refer to PACKAGING INFORMATION for the mounting condition.

## RECOMMENDED OPERATING CONDITIONS

| PARAMETER | SYMBOL | MIN. | TYP. | MAX. | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Input Voltage | VIN | - | - | 6.0 | V |
| Applied voltage to $\mathrm{VOUT}^{\left({ }^{(1)}\right)}$ | Vout | Vout(t) | - | 6.0 | V |
| Lx Pin Current ${ }^{\left({ }^{*} 2\right)}$ | Itx | - | - | 3.5 | A |
| EN Pin Voltage | Ven | 0.0 | - | 6.0 | V |
| Operating Ambient Temperature | Topr | -40 | - | 105 | ${ }^{\circ} \mathrm{C}$ |
| Junction Temperature | Tj | -40 | - | 125 | ${ }^{\circ} \mathrm{C}$ |
| Input Capacitor (Effective Value) | $\mathrm{Clin}^{\text {a }}$ | $3.3{ }^{(* 3)}$ | - | $\left.1000{ }^{*} 4\right)$ | $\mu \mathrm{F}$ |

GND(AGND,PGND) are standard voltage for all of the voltage.
Vout(T) : Target Output voltage
 Regarding to support for OR connection or not, please refer to the operational explanation and NOTES ON USE.
${ }^{\left({ }^{*}\right)}$ ) Due to the Lx pin current, the junction temperature may cross over the maximum junction temperature. Please use within the range that does not cross over the maximum junction temperature.
${ }^{(* 3)}$ Some ceramic capacitors have an effective capacitance that is significantly lower than the nominal value due to the applied DC bias and ambient temperature. For the input / output capacitance of this IC, use an appropriate ceramic capacitor according to the DC bias usage conditions (ambient temperature, input / output voltage) so that the effective capacitance value is equal to or higher than the recommended component.
${ }^{(* 4)}$ If using a large-capacity capacitor such as an electrolytic capacitor or tantalum capacitor as the input capacitance, place a low ESR ceramic capacitor in parallel. If a ceramic capacitor is not placed, high-frequency voltage fluctuations will increase and the IC may malfunction.

## ELECTRICAL CHARACTERISTICS

| PARAMETER | SYMBOL | CONDITIONS |  | MIN. | TYP. | MAX. | UNITS | CIRCUIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Input Voltage | $\mathrm{V}_{1 \times}$ |  |  | - | - | 6.0 | V | - |
| Output Voltage | $V_{\text {Out }}$ | Voltage to start oscillation while $\mathrm{V}_{\text {OUT }}=\mathrm{V}_{\text {OUT(T) }} \times 1.03 \rightarrow \mathrm{~V}_{\text {OUT }(T)} \times 0.97$ |  | <E-1> | <E-2> | <E-3> | V | (5) |
| Operation Start Voltage | $\mathrm{V}_{\text {ST1 }}$ | $\mathrm{R}_{\mathrm{L}}=$ OPEN | A/B/C/D/E/F Type | - | - | 0.90 | V | (1) |
| Operation Hold Voltage | $\mathrm{V}_{\text {HLD }}$ | $\mathrm{R}_{\mathrm{L}}=$ OPEN | A/B/C/D/E/F Type | - | 0.65 | - | V | (1) |
| Quiescent Current (XCL105) | Iq | $\begin{aligned} & \mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {Out(T) }}+0.2 \mathrm{~V} \\ & \mathrm{~V}_{\text {Out }}=\mathrm{V}_{\text {OUT (T) }}+0.5 \mathrm{~V} \end{aligned}$ |  | - | 19.0 | 38.0 | $\mu \mathrm{A}$ | (3) |
| Input Pin Quiescent Current | Iq_in | $\begin{aligned} & V_{\text {IN }}=V_{\text {OUTTT }}-0.2 \mathrm{~V}, \\ & V_{\text {OUT }}=V_{\text {OUT }(T)}+0.5 \mathrm{~V} \end{aligned}$ | XCL105 C/F | - | 0.12 | 0.36 | $\mu \mathrm{A}$ | (3) |
|  |  |  | XCL105 M/L | - | 1.20 | 2.06 |  |  |
| Oscillation Frequency | fosc | $\mathrm{V}_{\text {IN }}=1.7 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=1.7 \mathrm{~V}$ |  | 1.02 | 1.20 | 1.38 | MHz | (5) |
| Maximum Duty Cycle | $\mathrm{D}_{\text {max }}$ | $\mathrm{V}_{\text {IN }}=1.7 \mathrm{~V}, \mathrm{~V}_{\text {Out }}=1.7 \mathrm{~V}$ |  | 85 | 91 | 98 | \% | (5) |
| Minimum Duty Cycle | $\mathrm{D}_{\text {MIN }}$ | $\mathrm{V}_{\text {out }}=\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {OUT(T) }}+0.5 \mathrm{~V}$ |  | - | - | 0 | \% | (5) |
| PFM Switching Current (XCL105) | IPFM | $\begin{aligned} & V_{\text {IN }}=1.7 \mathrm{~V}, \\ & \mathrm{R}_{\mathrm{L}}: ~ O P E N \end{aligned}$ |  | - | 280 | 500 | mA | (1) |
| Stand-by Current | $\mathrm{I}_{\text {stв }}$ | $\begin{aligned} & V_{\mathbb{I N}}=V_{L L}=6.0 \mathrm{~V}, \\ & V_{E N}=0.0 V^{(1)} \end{aligned}$ | A/D/G/J Type | - | 0.0 | 1.0 | $\mu \mathrm{A}$ | (8) |
|  |  |  | B/E/H/K Type | - | 0.0 | 1.0 | $\mu \mathrm{A}$ | (7) |
|  |  |  | C/F/M/L Type | - | 0.16 | 1.0 | $\mu \mathrm{A}$ | (8) |
| Lx SW "Nch" ON Resistance | RLxN | $\mathrm{V}_{\text {IN }}=3.3 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=1.7 \mathrm{~V}$ |  | - | $0.17{ }^{(3)}$ | - | $\Omega$ | - |
| Lx SW "Pch" ON Resistance | RLXP | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {Lx }}=3.3 \mathrm{~V}$, $\mathrm{l}_{\text {out }}=200 \mathrm{~mA}$ |  | - | $0.23{ }^{(2)}$ | - | $\Omega$ | (4) |
| $\underset{\text { Current }}{\text { Lx SW "H" Leakage }}$ | $\mathrm{I}_{\text {LXLH }}$ | $\begin{aligned} & V_{\mathrm{IN}}=6.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{EN}}=0 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{Lx}}=6.0 \mathrm{~V}^{(11)} \end{aligned}$ | A/C/D/F/G/M/J/L Type | - | 0.0 | 1.0 | $\mu \mathrm{A}$ | (8) |
|  |  |  | B/E/H/K Type |  |  |  |  | (7) |
| Lx SW "L" Leakage Current (XCL105 C/F/M/L) | ILXLL | $\mathrm{V}_{\text {IN }}=0.0 \mathrm{~V}, \mathrm{~V}_{\text {EN }}=0.0 \mathrm{~V}, \mathrm{~V}_{\text {Lx }}=0.0 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=6.0 \mathrm{~V}$ |  | - | 0.0 | 1.0 | $\mu \mathrm{A}$ | (2) |
| Current Limit | LIM | $\mathrm{V}_{1 \times}=\mathrm{V}_{\text {OUT }(T)}-0.2 \mathrm{~V}, \mathrm{R}_{\mathrm{Lx}}=0.5 \Omega$ |  | <E-4> | <E-5> | <E-6> | A | (6) |
| Integral Latch Time (D/E/F/J/K/L Type) | tlat | $\mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\text {OUT (T) }}-0.3 \mathrm{~V}, \mathrm{R}_{\mathrm{Lx}}=0.5 \Omega$, <br> Time from current limit start to stop Lx oscillation |  | 45 | 200 | 450 | $\mu \mathrm{s}$ | (6) |
| Latch Release Voltage (D/E/F Type) | $V_{\text {LAt_R }}$ | After the integral latch was operated, $\mathrm{R}_{\mathrm{L}}:$ OPEN, $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {OUT }(\mathrm{T})}-0.2 \mathrm{~V} \rightarrow 0.9 \mathrm{~V}$ |  | 0.9 | 1.2 | 1.5 | V | (1) |
| Short-circuit Protection Threshold Voltage (D/E/F/J/K/L Type) | $V_{\text {SHort }}$ | $\mathrm{V}_{\mathbb{N}}=\mathrm{V}_{\text {OUT(T)- }}-0.2 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=0 \Omega$ |  | - | $\mathrm{V}_{1 \times}{ }^{(+3)}$ | - | V | (1) |

## XCL104/XCL105 Series

ELECTRICAL CHARACTERISTICS (Continued)
$\mathrm{Ta}=25^{\circ} \mathrm{C}$

| PARAMETER | SYMBOL | CONDITIONS |  | MIN. | TYP. | MAX. | UNITS | CIRCUIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Soft-Start Time | $\mathrm{t}_{\text {ss }}$ | $V_{\text {IN }}=V_{\text {OUTT(T) }} \times 0.85, V_{\text {OUT }}=V_{\text {OUT(T) }} \times 0.9,$ <br> After " H " is fed to EN , the time by when clocks are generated at Lx pin. |  | 0.58 | 1.20 | 2.50 | ms | (5) |
| $C_{L}$ Discharge Resistance (A/D/G/J Type) | $\mathrm{R}_{\mathrm{DCHG}}$ | $\mathrm{V}_{\text {IN }}=3.3 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=3.3 \mathrm{~V}, \mathrm{~V}_{\text {EN }}=0 \mathrm{~V}$ |  | 100 | 180 | 400 | $\Omega$ | (2) |
| EN "H" Voltage | $\mathrm{V}_{\text {ENH }}$ | $\mathrm{V}_{\text {out }}=\mathrm{V}_{\text {Out }}$ (T)-0.15V, Applied voltage to $\mathrm{V}_{\text {EN }}$, Voltage changes Lx to be generated. | $\mathrm{Ta}=25^{\circ} \mathrm{C}$ | 0.80 | - | 6.00 |  |  |
|  |  |  | $\begin{aligned} & \mathrm{Ta}=-40 \\ & \sim 105^{\circ} \mathrm{C}^{(3)} \end{aligned}$ | 0.80 | - | 6.00 | V | (5) |
| EN "L" Voltage | $\mathrm{V}_{\text {EnL }}$ | $V_{\text {out }}=V_{\text {out }}$ (T) -0.15 V , <br> Applied voltage to $\mathrm{V}_{\mathrm{EN}}$, <br> Voltage changes Lx to " H " level | $\mathrm{Ta}=25^{\circ} \mathrm{C}$ | GND | - | 0.20 | V | (5) |
|  |  |  | $\begin{aligned} & \mathrm{Ta}=-40 \\ & \sim 15^{\circ} \mathrm{C}^{(+3)} \end{aligned}$ | GND | - | 0.20 |  |  |
| EN "H" Current | $\mathrm{I}_{\text {ENH }}$ | $\mathrm{V}_{\text {IN }}=6.0 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=6.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{Lx}}=6.0 \mathrm{~V}, \mathrm{~V}_{\text {EN }}=6.0 \mathrm{~V}$ |  | -0.1 | 0.0 | 0.1 | $\mu \mathrm{A}$ | (2) |
| EN "L" Current | $\mathrm{I}_{\text {enl }}$ | $\mathrm{V}_{\text {IN }}=6.0 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=6.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{Lx}}=6.0 \mathrm{~V}, \mathrm{~V}_{\text {EN }}=0.0 \mathrm{~V}$ |  | -0.1 | 0.0 | 0.1 | $\mu \mathrm{A}$ | (2) |
| Thermal Shutdown Temperature | $\mathrm{T}_{\text {TSD }}$ |  |  | - | 150 | - | ${ }^{\circ} \mathrm{C}$ | - |
| Hysteresis Width | $\mathrm{T}_{\text {HYS }}$ |  |  | - | 25 | - | ${ }^{\circ} \mathrm{C}$ | - |
| UVLO Release Voltage (G/H/M/J/K/L Type) | Vuvlo_r | $\mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega$, While $\mathrm{V}_{\mathrm{IN}_{\mathrm{N}}}=0.2 \mathrm{~V} \rightarrow 1.8 \mathrm{~V}$, Voltage to start oscillation |  | 1.40 | 1.60 | 1.73 | V | (1) |
| UVLO Hysteresis Width (G/H/M/J/K/L Type) | VuvLo_hrs |  |  | 0.070 | 0.150 | 0.215 | V | (1) |
| UVLO Detect Delay (G/H/M/J/K/L Type) | $\mathrm{t}_{\mathrm{p}}$ | After $\mathrm{V}_{\text {IN }}=\left(\mathrm{V}_{\text {OUT }(T)}+\mathrm{V}_{\text {UvLI_R }}\right) / 2 \rightarrow 0.65 \mathrm{~V}$, time to stop oscillation |  | 52 | 200 | 425 | $\mu \mathrm{s}$ | (1) |
| Inductance Value | L | Test Frequency $=1 \mathrm{MHz}$ |  | - | 4.7 | - | $\mu \mathrm{H}$ | - |

Test conditions : unless otherwise stated, $\mathrm{V}_{\mathbb{I}}=1.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{EN}}=3.3 \mathrm{~V}, \mathrm{Lx}=\mathrm{OPEN}, \mathrm{R}_{\mathrm{Lx}}=56 \Omega$
Vout(T) : Target voltage

| ${ }^{\left({ }^{(1)}\right)} \mathrm{A} / \mathrm{C} / \mathrm{D} / \mathrm{F} / \mathrm{G} / \mathrm{M} / \mathrm{J} / \mathrm{L}$ types | $:$ Vout=0.0V |
| :---: | :--- |
| B/E/H/K types | $:$ Vout=OPEN |

${ }^{\left({ }^{*} 2\right)}$ Design value of $A / C / D / F / G / M / J / L$ types
${ }^{(* 3)}$ Design value

Table 1. External Components $R_{L}$ Table

| Vout(t) | RL |
| :---: | :---: |
| $1.8 \mathrm{~V} \leqq \mathrm{Vout}_{\text {(T) }}<2.1 \mathrm{~V}$ | $150 \Omega$ |
| $2.1 \mathrm{~V} \leqq$ Vout(T) $<3.1 \mathrm{~V}$ | $220 \Omega$ |
| $3.1 \mathrm{~V} \leqq \mathrm{~V}_{\text {OUT }(\text { T })}<4.3 \mathrm{~V}$ | $330 \Omega$ |
| $4.3 \mathrm{~V} \leqq$ Vout $(\mathrm{T}) \leqq 5.5 \mathrm{~V}$ | $470 \Omega$ |

## ELECTRICAL CHARACTERISTICS (Continued)

Table 2. SPEC Table

| NOMINAL OUTPUT VOLTAGE | Vout |  |  | lııM |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | <E-1> | <E-2> | <E-3> | <E-4> | <E-5> | <E-6> |
| UNITS | V | V | V | A | A | A |
| Vout(t) | MIN. | TYP. | MAX. | MIN. | TYP. | MAX. |
| 1.8 | 1.764 | 1.800 | 1.836 | - | 1.28 | 3.10 |
| 1.9 | 1.862 | 1.900 | 1.938 | - | 1.47 | 3.10 |
| 2.0 | 1.960 | 2.000 | 2.040 | - | 1.65 | 3.10 |
| 2.1 | 2.058 | 2.100 | 2.142 | - | 1.81 | 3.10 |
| 2.2 | 2.156 | 2.200 | 2.244 | - | 1.95 | 3.10 |
| 2.3 | 2.254 | 2.300 | 2.346 | - | 2.07 | 3.10 |
| 2.4 | 2.352 | 2.400 | 2.448 | - | 2.17 | 3.10 |
| 2.5 | 2.450 | 2.500 | 2.550 | - | 2.26 | 3.10 |
| 2.6 | 2.548 | 2.600 | 2.652 | - | 2.32 | 3.10 |
| 2.7 | 2.646 | 2.700 | 2.754 | - | 2.37 | 3.10 |
| 2.8 | 2.744 | 2.800 | 2.856 | - | 2.40 | 3.10 |
| 2.9 | 2.842 | 2.900 | 2.958 | - | 2.41 | 3.10 |
| 3.0 | 2.940 | 3.000 | 3.060 | 1.52 | 2.42 | 3.10 |
| 3.1 | 3.038 | 3.100 | 3.162 | 1.52 | 2.42 | 3.10 |
| 3.2 | 3.136 | 3.200 | 3.264 | 1.52 | 2.42 | 3.10 |
| 3.3 | 3.234 | 3.300 | 3.366 | 1.53 | 2.42 | 3.10 |
| 3.4 | 3.332 | 3.400 | 3.468 | 1.53 | 2.42 | 3.10 |
| 3.5 | 3.430 | 3.500 | 3.570 | 1.54 | 2.42 | 3.10 |
| 3.6 | 3.528 | 3.600 | 3.672 | 1.54 | 2.42 | 3.10 |
| 3.7 | 3.626 | 3.700 | 3.774 | 1.54 | 2.42 | 3.10 |
| 3.8 | 3.724 | 3.800 | 3.876 | 1.55 | 2.42 | 3.10 |
| 3.9 | 3.822 | 3.900 | 3.978 | 1.55 | 2.42 | 3.10 |
| 4.0 | 3.920 | 4.000 | 4.080 | 1.55 | 2.42 | 3.10 |
| 4.1 | 4.018 | 4.100 | 4.182 | 1.56 | 2.42 | 3.10 |
| 4.2 | 4.116 | 4.200 | 4.284 | 1.56 | 2.42 | 3.10 |
| 4.3 | 4.214 | 4.300 | 4.386 | 1.57 | 2.42 | 3.10 |
| 4.4 | 4.312 | 4.400 | 4.488 | 1.57 | 2.42 | 3.10 |
| 4.5 | 4.410 | 4.500 | 4.590 | 1.57 | 2.42 | 3.10 |
| 4.6 | 4.508 | 4.600 | 4.692 | 1.58 | 2.42 | 3.10 |
| 4.7 | 4.606 | 4.700 | 4.794 | 1.58 | 2.42 | 3.10 |
| 4.8 | 4.704 | 4.800 | 4.896 | 1.58 | 2.42 | 3.10 |
| 4.9 | 4.802 | 4.900 | 4.998 | 1.59 | 2.42 | 3.10 |
| 5.0 | 4.900 | 5.000 | 5.100 | 1.59 | 2.42 | 3.10 |
| 5.1 | 4.998 | 5.100 | 5.202 | 1.59 | 2.42 | 3.10 |
| 5.2 | 5.096 | 5.200 | 5.304 | 1.60 | 2.42 | 3.10 |
| 5.3 | 5.194 | 5.300 | 5.406 | 1.60 | 2.42 | 3.10 |
| 5.4 | 5.292 | 5.400 | 5.508 | 1.61 | 2.42 | 3.10 |
| 5.5 | 5.390 | 5.500 | 5.610 | 1.61 | 2.42 | 3.10 |

## XCL104/XCL105 Series

## -TEST CIRCUITS

< Circuit No. 1 >

※External Components
$\mathrm{C}_{\mathrm{IN}}: 10 \mu \mathrm{~F}($ ceramic $)$
L : $4.7 \mu \mathrm{H}$
$C_{L}: 30 \mu \mathrm{~F}($ ceramic $)$
< Circuit No. 3 >

< Circuit No. 5 >

< Circuit No. 7 >

< Circuit No. 2 >

< Circuit No. $4>$

< Circuit No. 6 >

< Circuit No. 8 >


## TYPICAL APPLICATION CIRCUIT / PARTS SELECTION GUIDE



【Typical Examples】

|  | CONDITIONS | MANUFACTURER | PRODUCT NUMBER | VALUE | SIZE(L×W $\times$ T) |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{C}_{\mathrm{IN}^{(* 1)}}$ | - | Murata | GRM188D71A106MA73 | $10 \mu \mathrm{~F} / 10 \mathrm{~V}$ | $1.6 \times 0.8 \times 0.8 \mathrm{~mm}$ |
| $\mathrm{C}_{\mathrm{L}}{ }^{\left({ }^{*} 2\right)}$ | Input Current $\leqq 1.0 \mathrm{~A}$ | Murata | GRM188D71A106MA73 | $10 \mu \mathrm{~F} / 10 \mathrm{~V} \times 2$ | $1.6 \times 0.8 \times 0.8 \mathrm{~mm}$ |
|  | $1.0 \mathrm{~A}<$ Input Current | Murata | GRM188D71A106MA73 | $10 \mu \mathrm{~F} / 10 \mathrm{~V} \times 3$ | $1.6 \times 0.8 \times 0.8 \mathrm{~mm}$ |

(*1) Use an appropriate ceramic capacitor according to the DC bias usage conditions (ambient temperature, input / output voltage) so that the effective capacitance value is equal to or higher than the recommended component.
(*2) If a tantalum or low ESR electrolytic capacitor is used for the $C_{L}$, the ripple voltage will increase. When using an electrolytic capacitor for the $\mathrm{C}_{\mathrm{L}}$, connect a ceramic capacitor in parallel before use.

In addition, when a large-capacity ceramic capacitor, tantalum, low ESR electrolytic capacitor, etc. are used for the $\mathrm{C}_{\mathrm{L}}$, the following operations may occur.
(a) The output voltage may become unstable under heavy load.
(b) For products with an integral latch, the integral latch function may operate and the output voltage may not rise to the target voltage if the current limit function continues after the start mode is completed.

## XCL104/XCL105 Series

## TYPICAL APPLICATION CIRCUIT/PARTS SELECTION GUIDE

<Load disconnection function: A/D/G/J types>
It is configured to cut off the continuity from the input side to the output side during standby mode ( $\mathrm{EN}=$ " " " ").
For the A/D/G/J types, the $C_{L}$ discharge function operates when the charge in the output capacitance is quickly discharged. In order to prevent the application from malfunction, the charge remaining in the output capacitance.


## <Bypass mode: XCL105 B/E/H/K types>

The Pch synchronous switching FET is turned on to connect the input side and output side during the standby mode (EN = "L"), By operating in this bypass mode, current can be supplied to the output side even during standby mode, and it is possible to drive the subsequent devices
In this configuration, a system that can be driven by a low voltage at the standby or sleep mode, it is set to bypass mode and the input voltage is output to the output side. Where communication or calculation that requires a high drive voltage is performed in the active mode, the system is driven by activating of the IC and performing boosting operation.
This operation can dramatically reduce the power consumption in the standby mode and improve the battery life.


## TYPICAL APPLICATION CIRCUIT/PARTS SELECTION GUIDE

<OR connection: XCL105 C/F/M/L types>
The XCL105 C/F/M/L types compare the input voltage VIN and output voltage Vout to optimally control the orientation of the parasitic diode of the Pch synchronous switching FET even during standby mode, so that the input side and output side do not connect through the parasitic diode of the Pch synchronous switching FET.
Even if an external voltage higher than the VIN voltage is applied to the output side by controlling this parasitic diode, the input side and output side do not connect, and output OR connection is possible.

This type can be used for OR connection is possible such as backup power supply and output OR connection assuming the input of an external power supply.
Moreover, the design which suppresses the discharge current from a battery at the time of OR connection is adopted. This can suppress battery discharge during OR connection.


[^0]
## XCL104/XCL105 Series

## OPERATIONAL EXPLANATION

This IC consists of a reference voltage source, ramp wave circuit, error amplifier, PWM comparator, phase compensation circuit, Nch driver FET, Pch synchronous switching FET and current limiter circuit.


XCL104/XCL105 A/D types

The main function of this IC is a current mode control step-up DC/DC converter that supports low ESR ceramic capacitors. By adopting current mode control and increasing the oscillation frequency to a high frequency, the size of peripheral parts has been reduced.

The current feedback circuit monitors the Nch driver FET's turn-on current for each switching operation, and modulates the error amplifier output signal to provide multiple feedback signals. This enables a stable feedback loop even when a low ESR capacitor, such as a ceramic capacitor is used, and the output voltage is stabilized.

Regarding to the parts required for operation, select the constants by referring to the part selection guide. If a component that is significantly different from this constant is used, proper phase compensation may not be obtained, and DC/DC may operate unstable. Also, when using a capacitance other than a ceramic capacitor, use a low ESR capacitance. If a capacitor with a high ESR is used, heat generation of the capacitor and unstable DC/DC operation may occur.
<Driver configuration / Load disconnection control (parasitic diode control)>
A Pch FET is built-in on the High Side and an Nch FET is built-in on the Low Side.
In general Pch FETs, there is a parasitic diode with the source as the cathode and the drain as the anode, but the Pch FETs on the High Side of the XCL104/XCL105 series control the polarity of the parasitic diode.
It is possible to disconnect the load between the input and output sides by controlling this parasitic diode during standby and prevent reverse flow from the output side to the input side when external voltage is applied from the output side.
The control of the polarity of the parasitic diode depends on the types.

[^1]
## OPERATIONAL EXPLANATION

<Normal operation>
The error amplifier compares the internal reference voltage with FB voltage. In order to input a signal to the PWM comparator, the phase compensation is performed on the resulting error amplifier output. The PWM comparator compares, the signal from the error amplifier with the ramp wave from the ramp wave circuit, and delivers the resulting output to the buffer driver circuit to control the duty during PWM control. The output voltage is stabilized by performing these controls continuously.

## $\underline{\text { XCL104 Series }}$

The XCL104 Series (PWM control) performs switching at a set switching frequency fosc regardless of the output current. When the Vout voltage becomes higher than $\mathrm{Vout}_{\text {out }}$, the $\mathrm{V}_{\text {out }}$ voltage is reduced until the output voltage reaches $\mathrm{V}_{\text {out( } \mathrm{T})}$.


XCL104 Series : Example of light load operation


XCL104 Series: Example of heavy load operation

## XCL105 Series

The XCL105 Series (PWM/PFM automatic switching control) lowers the switching frequency during light loads by turning on the Low side driver FET when the coil current reaches the PFM current (IPFM). This operation reduces the loss during light loads and achieves high efficiency from light to heavy loads. As the output current increases, the switching frequency increases proportional to the output current, and when the switching frequency increases fosc, the circuit switches from PFM control to PWM control and the switching frequency becomes fixed.


XCL105 Series: Example of light load operation


XCL105 Series: Example of heavy load operation

## XCL104/XCL105 Series

## OPERATIONAL EXPLANATION

$<\mathrm{Vout}_{\text {(T) }}<\mathrm{V}_{\text {IN }}$ : Input through $>$
The behavior of this IC differs depending on the type when an input voltage higher than the set output voltage is applied.
The details of operation for each type are as follows.

## XCL105 C/F/M/L types: Load Disconnection + No CL Discharge

The XCL105 C/F/M/L types turn off the Pch synchronous switching FET when a voltage higher than the set output voltage is applied to the input voltage, and fix the polarity of the parasitic diode to cathode: Vout, anode: Lx

Under this condition, current flows from the input side to the output side via the parasitic diode of the Pch synchronous switching FET, and the output voltage is as follows. When continuously supplying current to the output side via the parasitic diode of the Pch synchronous switching FET, the output current should be 100 mA or less.

$$
\begin{aligned}
& \mathrm{V}_{\text {OUT(T) }} \leqq \mathrm{V}_{\text {IN }} \leqq \mathrm{V}_{\text {OUT(T) }}+\mathrm{VF} \quad: \mathrm{V}_{\text {OUT }} \fallingdotseq \mathrm{V}_{\text {Out(T) }} \\
& \mathrm{V}_{\text {OUT(T) }}+\mathrm{VF}<\mathrm{V}_{\text {IN }} \quad: \mathrm{V}_{\text {OUT }} \fallingdotseq \mathrm{V}_{\text {IN }}-\mathrm{VF} \\
& \text { * VF : Parasitic diode of Pch synchronous switching FET VF }
\end{aligned}
$$

## Except XCL105 C/F/M/L types

For all types except XCL105 C/F/M/L types, when the input voltage higher than the set output voltage, the Pch synchronous switching FET is turned on.

By this operation, the output voltage will be as follows.

$$
V_{\text {OUT }(T)} \leqq \mathrm{V}_{\text {IN }} \quad: \text { VOUT }^{\text {O}} \mathrm{V}_{\text {IN }}-\text { Iout } \times \operatorname{RLXP}(\text { TYP. } 0.23 \Omega)
$$

## OPERATIONAL EXPLANATION

<EN function / load disconnection function / bypass mode>
When a " H " voltage $\left(\mathrm{V}_{\mathrm{ENH}}\right)$ is input to the EN pin, the output voltage is raised by the start-up mode, and then normal operation starts.

When the "L" voltage ( $\mathrm{V}_{\mathrm{ENL}}$ ) is input to the EN pin, the IC enters the standby mode, and the current consumption is reduced to the standby current Istв.
The polarity of the parasitic diodes of the Pch synchronous switching FET and Pch synchronous switching FET in the standby mode and the operation of the $C_{\llcorner }$discharge function depending on the types.

The details of the operation for each type are as follows.

A/D/G/J types : Load disconnection function with CL discharge function
When the Nch driver FET and Pch synchronous switching FET are turned off, the CL discharge function operates.
When the $C_{L}$ discharge function operates, the charge on the output side is quickly discharged and the output voltage is reduced.
When the Nch driver FET and Pch synchronous switching FET are turned off and fix the polarity of the parasitic diode of the Pch synchronous switching FET to anode: Vout and cathode: Lx, the conduction from the input side to the output side is cut off.

The current consumption during this operation is the standby current Istв (TYP. $0.0 \mu \mathrm{~A}$ ).

## XCL105 C/F/M/L types : Load disconnection function without CL discharge function

Nch driver FET and Pch synchronous switching FET are turned off.
Even in standby mode, the VIN voltage is compared with the Vout voltage, and the polarity of the parasitic diode for the Pch synchronous switching FET is controlled so that the input and output sides do not connect through the parasitic diode of the Pch synchronous switching FET.
Even if an external voltage higher than the VIN voltage is applied to the output side by controlling this parasitic diode, the input side and the output side will not connect, and the output OR connection is possible.

The current consumption during this operation is the standby current Istв (TYP. $0.16 \mu \mathrm{~A}$ ).

## XCL105 B/E/H/K types : Bypass mode

When the Nch driver FET turned off and the Pch synchronous switching FET turned on, the resistance between the Lx and Vout becomes RLxp (TYP. 0.23 $)$ and connects.
This operation allows current to be supplied to the output side even in the standby mode, enabling to drive the subsequent devices.

The current consumption during this operation is the standby current Istв (TYP. $0.0 \mu \mathrm{~A}$ ).

In standby mode (EN="L") Operation list

| TYPE | Nch Driver FET <br> /Pch Driver FET | Vout <br> pin Voltage | CL <br> Discharge | IstB (TYP.) | Applied Voltage to the Vout pin <br> (EN="L") |
| :---: | :---: | :---: | :---: | :---: | :---: |
| A/D/G/J | OFF <br> /OFF | GND | Active | $0.0 \mu \mathrm{~A}$ | No <br> (CL Discharge Operation) |
| C/F/M/L <br> (Only XCL105) | OFF <br> /OFF | OPEN | - | $0.16 \mu \mathrm{~A}$ | Yes |
| B/E/H/K <br> $($ Only XCL105) | OFF <br> /ON | VIN | - | $0.0 \mu \mathrm{~A}$ | No <br> (Reverse Flow toward the input) |

## OPERATIONAL EXPLANATION

< Startup Mode / Soft Start >
This function gradually boosting the Vout voltage up to the set output voltage to suppress the inrush current. The start-up mode is activated when the EN pin is input to " H " and the IC is turned from standby mode to active mode.
The short circuit protection and integral latch functions of the XCL104 D/J types and XCL105 D/E/F/J/K/L types do not operate during the startup mode.
The details of the operation for each type are as follows.

## XCL104/XCL105 A/D/G/J types, XCL105 C/F/M/L types : load disconnection function

(1) Vout $\leqq \mathrm{V}_{\text {IN }}$

The current is supplied to the output side via Pch synchronous switching FET.
Since the Pch synchronous switching FET supplies current to the output side while the current is limited, the Vout is gradually increased to $\mathrm{V}_{\mathrm{IN}}$.

## (2) $\mathrm{V}_{\text {OUT }}<\mathrm{V}_{\text {OUt(T) }} \times 0.9$

After the Vout voltage reaches to $\mathrm{VIN}_{\mathrm{I}}$, the internal reference voltage of the IC is raised slowly.
When the FB voltage, which is the voltage divided by the Vout voltage with R RB1 and RFB2, becomes lower than the internal reference voltage of the IC, the switching operation starts.
The slope of the Vout voltage rise is proportional to the slope of the internal reference voltage of the IC.
(3) Normal operation

When the Vout voltage reaches $V_{\text {Out(T) }} \times 0.9$, the start-up mode is terminated, and the device shifts to normal operation. However, under the condition of heavy load and large output capacitance, it may not be able to rise to the set output voltage within the start-up period of the reference voltage. In this case, even if the set output voltage is not reached, the IC will shift from start-up mode to normal operation after the completion of the start-up of the reference voltage.


## XCL105 B/E/H/K types : Bypass mode

(1) $\mathrm{V}_{\text {OUt }}<\mathrm{V}_{\text {OUT(T) }} \times 0.9$

After becoming active, the internal reference voltage of the IC is raised slowly.
When the FB voltage, which is the voltage divided by the Vout voltage with RFB1 and RFB2, becomes lower than the internal reference voltage of the IC, the switching operation starts, and the output voltage is increased from $V_{I N}$.
The slope of the Vout voltage rise is proportional to the slope of the internal reference voltage of the IC.
(2) Normal operation

When the $V_{\text {Out }}$ voltage reaches $V_{\text {OUT(T) }} \times 0.9$, the start-up mode is terminated, and the device shifts to normal operation. However, under the condition of heavy load and large output capacitance, it may not be able to rise to the set output voltage within the start-up period of the reference voltage. In this case, even if the set output voltage is not reached, the IC will shift from start-up mode to normal operation after the completion of the start-up of the reference voltage.


## OPERATIONAL EXPLANATION

<Current Limit / Short Circuit Protection / Integral Latch>
The current limit function of this IC monitors the current flowing in the Nch driver (=coil current) for each switching cycle, and when the current flowing through the Nch driver FET reached the current limit value ILIM (TYP. 2.42A @ Vout (T) $=5.0 \mathrm{~V}$ ), it will be in the overcurrent detection state.

When the overcurrent detection state occurs, the Nch driver FET is turned off and the detection state is maintained during this switching cycle. If the current flowing to the Nch driver FET is less than the current limit value lum in the next switching cycle, the overcurrent detection state is released.

If the overcurrent detection state is continued or if there is a significant drop in output voltage, the short circuit protection function and integral latch function are activated depending on the type.

The details of the operation for each type are as follows.

No short circuit protection/integral latch: XCL104 A/G types, XCL105 A/B/C/G/H/M types
(1) If the current flowing in the Nch driver FET reaches the current limit value lıim, it will be in the overcurrent detection state. The Nch driver FET turns off and remains off during this switching cycle.
(2) In the next switching cycle, the Nch driver FET turns on.

If the overcurrent state continues and the current flowing to the Nch driver FET reaches the current limit value lıim, the overcurrent detection state is maintained.
(2) If overcurrent state continues, (1) and (2) are repeated.


## XCL104/XCL105 Series

<Current Limit / Short Circuit Protection / Integral Latch (Continued)>

## Short circuit protection/with integral latch : XCL104 D/J types, XCL105 D/E/F/J/K/L types

In the XCL104 D/J types and XCL105 D/E/F/J/K/L types, if the overcurrent detection state continues and the output voltage drops significantly, the driver FETs are turned off and latch stopped by the operations shown in (a) and (b).

Case (a) : When the overcurrent detection status is maintained
(1) When the current flowing to the Nch driver FET reaches the current limit value lum, the overcurrent detection state occurs. The Nch driver FET is turned off and kept off during this switching cycle.
When the XCL104 D/J types and XCL105 D/E/F/J/K/L types become to the overcurrent detection status, the integral latch timer starts counting.
(2) In the next switching cycle, the Nch driver FET turns on.

If the over-current state continues and the current flowing to Nch driver FET reaches the current limit lum, the over current detection state is maintained.
(3) When the overcurrent detection state is maintained and the integral latch timer continues to count $\mathrm{t}_{\text {LAT }}$ (TYP. : $200 \mu \mathrm{~s}$ ), the Nch driver FET and Pch synchronous switching FET are turned off and the integral latch function latches.
However, for XCL104 D type and XCL105 D/E/F types, the integral latch function does not operate when the input voltage is less than the latch release voltage VLat_r(TYP. 1.2V).

Case (b) : When the output voltage drops significantly
(1) When the current flowing to Nch driver FET reaches the current limit value lıim, the overcurrent detection state occurs. The Nch driver FET is turned off and kept off during this switching cycle.
(2) In the next switching cycle, the Nch driver FET turns on.

If the over-current state continues and the current flowing to Nch driver FET reaches the current limit lıim, the over-current detection state is maintained.
(3) If the output voltage becomes equal or less than the short circuit protection threshold voltage $\mathrm{V}_{\text {Short }}(\mathrm{TYP}$. Vin) during the over current detection state, the Nch driver FET and Pch synchronous switching FET are turned off and the short circuit protection function operates and latches.
However, for XCL104 D type and XCL105 D/E/F types, the short circuit protection function does not operate when the input voltage is equal to or less than the latch release voltage VLAT_R(TYP. 1.2V).

Conditions for recovery from latch stop
There are two conditions for recovery from latch stop by the current limited integral latch timer and short circuit protection. In addition, the recovery from the latch stop raises the output voltage via the start-up mode and shifts to normal operation.

## Without UVLO function: XCL104 D type, XC105 D/E/F types

- Input the "L" voltage to the EN pin to put it in the standby mode and then put it in the active mode.
- Set the input voltage $\mathrm{V}_{\mathrm{IN}}$ below the latch release voltage $\mathrm{V}_{\text {LAT_R }}(\mathrm{TYP} .1 .2 \mathrm{~V})$.

With UVLO function: XCL104 J type, XCL105 J/K/L types

- Input the "L" voltage to the EN pin to put it in the standby mode and then put it in the active mode.
- After setting the input voltage to Vuvlo_r-Vuvlo_Hys or less and setting the UVLO detection state, apply the voltage above Vuvlo_r to the normal state.


Case (a)


Case (b)

## OPERATIONAL EXPLANATION

<Thermal shutdown>
The junction temperature is monitored to protect the IC from thermal destruction.
When the junction temperature reaches the thermal shutdown detection temperature $\mathrm{T}_{\text {TSD }}$ (TYP. $150^{\circ} \mathrm{C}$ ), the thermal shutdown activated, and the Nch driver FET and Pch synchronous switching FET are turned off, and the output voltage drops. When the chip temperature drops to the thermal shutdown release temperature $\mathrm{T}_{\text {TSD }}-\mathrm{T}_{\text {HYS }}\left(T Y P .125^{\circ} \mathrm{C}\right.$ ) by stopping the current supply, the output voltage is turned on by the start-up mode, and then normal operation starts.

In order to suppress the current consumption at the light load, XCL105 series stops the thermal shutdown function when the output current is small at the PFM control.

## <UVLO>

XCL104 G/J types and XCL105 G/H/M/J/K/L types have UVLO function.
If Vin voltage becomes equal or less than Vuvlo_r (TYP.1.60V)- Vuvlo_hys (TYP.0.15V), UVLO Detect Delay: $\mathrm{t}_{\mathrm{DF}}$ (TYP. : 200 $\mu \mathrm{s}$ ) continues, then UVLO becomes active.
When UVLO detection state is reached, the switching operation is stopped and Nch driver FET and Pch synchronous switching FET are turned off.
If $\mathrm{V}_{\text {IN }}$ voltage is higher than $V_{\text {UvLo_R }}$, the output voltage is raised by the start-up mode, and then normal operation is performed.
The consumption current of the products with UVLO function is slightly higher than the products without UVLO function due to the operation of UVLO function

## <CLDischarge>

A/D/G/J types can discharge the electric charge at the output capacitor ( $C_{L}$ ) quickly during standby mode(EN="L") via the Nch FET located between Vout and GND.
Electric charge at the output capacitor $\left(\mathrm{C}_{\mathrm{L}}\right)$ is quickly discharged so that it may avoid application malfunction during standby mode.

Discharge time of the output capacitor $\left(C_{L}\right)$ is set by the $C_{L}$ discharge resistance ( $\mathrm{R}_{\mathrm{DCHG}}$ ) and the output capacitor $\left(\mathrm{C}_{\mathrm{L}}\right)$. However, the $\mathrm{Cl}_{\mathrm{L}}$ discharge resistance [ $\mathrm{RDCHg}_{\mathrm{dc}}$ ] is depends on the $\mathrm{V}_{\mathrm{IN}}$ or Vout. We recommend that you fully check actual performance.

$$
\begin{aligned}
& \mathrm{V}=\mathrm{VOUT}(\mathrm{~T}) \times \mathrm{e}^{-\mathrm{t} / \tau} \\
& \mathrm{t}=\tau \times \ln (\operatorname{VOUT}(\mathrm{T}) / \mathrm{V})
\end{aligned}
$$

[^2]
## NOTES ON USE

1) For the phenomenon of temporal and transitional voltage decrease or voltage increase, the IC may be damaged or deteriorated if IC is used beyond the absolute MAX. specifications. Also, if used under out of the recommended operating range, the IC may not operate normally or may cause deterioration.
2) Spike noise and ripple voltage arise in a switching regulator as with a DC/DC converter. These are greatly influenced by external component selection, such as the coil inductance, capacitance values, and board layout of external components. Once the design has been completed, verification with actual components should be done.
3) The DC/DC converter performance is greatly influenced by not only the ICs' characteristics, but also by those of the external components. Care must be taken when selecting the external components. Especially for capacitor, it is strongly recommended to use an appropriate capacitor according to the DC bias characteristics and temperature characteristics so that the effective capacitance value is equal to or greater than the recommended components under the actual usage conditions.
4) When the EN pin is open, the IC will operate indefinitely. Therefore, the EN pin should not be open and should be set to a fixed voltage. To prevent the IC and peripheral devices from malfunctioning due to pin-to-pin shorts, or to prevent the IC from being damaged by external noise, etc., it is recommended that a resistor of $1 \mathrm{M} \Omega$ or less be connected to the EN pin instead of connecting it directly to the $\mathrm{V}_{\mathrm{IN}}$.
5) When the boost ratio is small, PWM control oscillates intermittently.

This may cause the switching frequency to drop below fosc or increase output voltage ripple.
To suppress the ripple voltage, increase the capacitance value of the output capacitor and take measures
6) When connecting an external power supply to the output side, please use the XCL105 C/F/M/L types.

When using the XCL105 C/F/M/L type exclusion, depending on the bias conditions, the IC may break down and reverse flow to the input side may occur.
7) Depending on the detection delay time of the current limit circuit, a coil current exceeding the limit current value lum may flow.
8) Under the following conditions, the current limit function may not operate.

XCL104 D/J types, XCL105 D/E/F/J/K/L types are used the integral latch method. In this case, the integral latch of the current limit function and the latch stop by the short circuit protection function do not operate in these types

## The boost ratio is small

When the boost ratio is small, the required duty is low and the on-time of the Nch driver FET on the low side is short. If this on-time is shorter than the detection delay of the current limit circuit, the current limit function may not operate.

The boost ratio is high
When the boost ratio is high, the coil current may be limited below the current limit value due to the maximum duty ratio, onresistance, and DCR of the coil, and the current limit function may not operate.
9) The current limit function is a function that limits the current flowing through the Nch driver FET, and does not limit the current flowing through the Pch synchronous switching FET.
Therefore, an overcurrent may flow in the parasitic diode of the Pch synchronous switching FET and the Pch synchronous switching FET, and the IC may be destroyed.
10) XCL104 D/J types, XCL105 D/E/F/J/K/L types have short-circuit protection and integral latch function. If the output voltage drops sharply due to an output short circuit, etc. The internal power supply of the IC may drop sharply by the circuit delay of the $V_{D D}$ MAX circuit. As a result, the latch state of the short-circuit protection function may be reset and the latch stop may not be maintained.

## NOTES ON USE

11) If a large capacitor is used for the output capacitance or if a heavy load is pulled during startup mode, the follow operations may occur.

## With short circuit protection/integral latch : XCL104 D/J types, XCL105 D/E/F/J/K/L types

For the products with integral latch, after the start-up mode is completed, the integral latch function may not operate, and the output voltage may not rise to the set output voltage due to the continuation of the current limit function.

## Without short circuit protection/integral latch : XCL104 A/G types, XCL105 A/B/C/G/H/M types

The output voltage may not rise to the set output voltage during start-up mode.
After the start-up mode is completed, the output voltage rises up to the set output voltage while the current limit function is operating, so overshooting may occur in the output voltage.
12) When the input voltage is higher than the set output voltage, the XCL105C/F/M/L types turn off the Pch synchronous switching FET and fix the parasitic diode polarity to cathode: Vout and anode: Lx, when a voltage higher than the set output voltage is applied to the input voltage.

Under these conditions, when the output current is applied, the current flows through the parasitic diode of the Pch synchronous switching FET.
Continuously applying an output current of 100 mA or more or momentarily applying excessive output current may cause IC deterioration.

If the input voltage is higher than the set output voltage, or if you want the output current to input more than 100 mA continuously, we recommend using the types of XCL105C/F/M/L exclusion.
13) The XCL105 C/F/M/L types fix the parasitic diode polarity of the Pch synchronous switching FET to cathode: Vout and anode: Lx during the period of " $\mathrm{V}_{\text {OUt }}<\mathrm{V}_{\text {OUt(T) }} \times 0.9$ " in the startup mode.
If a current of 100 mA or more is applied to the parasitic diode of the Pch synchronous switching FET during this period, the output voltage may not rise to the set output voltage.
When the XCL105 C/F/M/L types are operate in the start-up mode, do not apply output current until the output voltage becomes higher than the input voltage and the switching operation starts.

14) This IC is a Inductor Built-in product, do not place it in an environment with a strong magnetic field such as near a magnet. The influence of a strong magnetic field may cause a decrease in inductance value, deterioration of efficiency, and abnormal operation of the IC.
15) Torex places an importance on improving our products and their reliability. We request that users incorporate fail safe designs and post aging protection treatment when using Torex products in their systems.

## XCL104/XCL105 Series

## ■NOTES ON USE

- Instructions of pattern layouts.

Especially noted in the pattern layout are as follows.
Please refer to the reference pattern layout on the following.
(a) Wire the large current line using thick, short connecting traces.

This makes it possible to reduce the wire impedance, which is expected to reduce noise and improve heat dissipation. If the wire impedance of the large current line is large, it may cause noise or the IC to not operate normally. Especially when the noise is large, the current limit function and the integral latch function may not work.
(b) Place the input capacitance $\mathrm{C}_{\mathrm{IN}}$, output capacitance $\mathrm{C}_{\mathrm{L}}$, inductor L and IC which the large current flows on the same surface. If they are placed on both sides, a large current will flow through Via, which has high impedance, it may cause noise and the IC may not operate normally.
(c) Please mount each external component as close to the IC as possible.

Especially place the output capacitance $C_{\llcorner }$near the IC and connect it with as low impedance as possible.
If the output capacity $C_{L}$ and IC are too far apart, it may cause noise or the IC may not operate normally
<The reference pattern layout>
Layer 1


Layer 3


Layer 2


Layer 4


## Notes on handling of product

(1) The coil mounted on this product complies with the general surface mount type chip inductor specifications, and may have scratches, flux stains, etc.
(2) Do not use this product in the following environments. Places exposed to water or salt water, places where condensation occurs, places where toxic gases (hydrogen sulfide, zinc acid, chlorine, ammonia, etc.) are present.
(3) Please do not wash this product with solvent.

## ■ABOUT IMPLEMENTATION

(1) This product is only suitable for reflow soldering (it is not suitable for flow soldering).
(2) This product uses solder to mount the coil on top of the package. This is no problem for regular circuit board mounted reflow, but if excessive impact is applied during reflow, the mounted coil could be moved out of position or the coil could fall off. Be careful not to strike the circuit board during circuit board mounting reflow.

## XCL104/XCL105 Series

## TYPICAL PERFORMANCE CHARACTERISTICS

(1) Efficiency vs. Output Current



## TYPICAL PERFORMANCE CHARACTERISTICS

(2) Output Voltage vs. Output Current


(3) Ripple Voltage vs. Output Current



## XCL104/XCL105 Series

## TYPICAL PERFORMANCE CHARACTERISTICS

(4) Output Voltage vs. Ambient Temperature


(5) Quies cent Current vs. Output Voltage

(6) Stand-by Current vs. Ambient Temperature


C/F/M/L Type


## TYPICAL PERFORMANCE CHARACTERISTICS

(7) Input Pin Quiescent Current vs. Ambient Temperature


(8) $C_{L}$ Discharge Resistance vs. Ambient Temperature


## XCL104/XCL105 Series

## TYPICAL PERFORMANCE CHARACTERISTICS

(9) Lx SW "Pch" ON Resistance vs. Ambient Temperature

(11) EN "H" Voltage vs. Ambient Temperature

(13) Lx SW "H" Leakage Current vs. Ambient Temperature

(10) Lx SW "Nch" ON Resistance vs. Ambient Temperature

(12) EN "L" Voltage vs. Ambient Temperature

(14) Lx SW "L" Leakage Current vs. Ambient Temperature


## TYPICAL PERFORMANCE CHARACTERISTICS

(15) Oscillation Frequency vs. Ambient Temperature

(17) Soft-Start Time vs. Ambient Temperature

(19) Operation Start Voltage vs. Ambient Temperature

(16) Maximum Duty Cycle vs. Ambient Temperature

(18) PFM Switching Current vs. Input Voltage

XCL105x50 $\mathrm{V}_{\text {OUT(T) }}=5.0 \mathrm{~V}$
$\mathrm{C}_{\mathrm{N}}=10 \mu \mathrm{~F}(\mathrm{GRM} 188 \mathrm{D71} 1 \mathrm{~A} 106 \mathrm{MA} 73)$
$C_{L}=30 \mu F(G R M 188 D 71 A 106 M A 73 \times 3)$

(20) Operation Hold Voltage vs. Ambient Temperature


## XCL104/XCL105 Series

## TYPICAL PERFORMANCE CHARACTERISTICS

(21) Current Limit vs. Ambient Temperature

(23) Latch Release Voltage vs. Ambient Temperature

(25) UVLO Hysteresis Voltage vs. Ambient Temperature

G/H/J/K/M/L Type

(22) Integral Latch Time vs. Ambient Temperature

D/E/F/J/K/L Type

(24) UVLO Release Voltage vs. Ambient Temperature

G/H/J/K/M/L Type

(26) UVLO Detect Delay vs. Ambient Temperature

G/H/J/K/M/L Type


## TYPICAL PERFORMANCE CHARACTERISTICS

(27) MAX Output Current vs. Input Voltage



## TYPICAL PERFORMANCE CHARACTERISTICS

(28) Start-up Operation

XCL105C33 ( $\mathrm{V}_{\text {OUT(T) }}=3.3 \mathrm{~V}$ )
$\mathrm{V}_{\text {IN }}=1.2 \mathrm{~V}, \mathrm{~V}_{\text {OUT }(\mathrm{T})}=3.3 \mathrm{~V}, \mathrm{RL}=\mathrm{OPEN}$ $\mathrm{C}_{\mathrm{IN}}=10 \mu \mathrm{~F}$ (GRM188D71A106MA73)
$C_{L}=30 \mu \mathrm{~F}(\mathrm{GRM} 188 \mathrm{D} 71 \mathrm{~A} 106 \mathrm{MA} 73 \times 3)$


XCL105B33 $\left(\mathrm{V}_{\text {OUT(T) }}=3.3 \mathrm{~V}\right)$
$\mathrm{V}_{\text {IN }}=1.2 \mathrm{~V}, \mathrm{~V}_{\text {out }}=3.3 \mathrm{~V}, \mathrm{RL}=\mathrm{OPEN}$
$\mathrm{C}_{\mathrm{IN}}=10 \mu \mathrm{~F}$ (GRM188D71A106MA73)
$\mathrm{C}_{\mathrm{L}}=30 \mu \mathrm{~F}(\mathrm{GRM} 188 \mathrm{D71A} 106 \mathrm{MA} 73 \times 3)$


XCL105C33 $\left(\mathrm{V}_{\text {OUT(T) }}=3.3 \mathrm{~V}\right)$
$\mathrm{V}_{\text {IN }}=1.2 \mathrm{~V}, \mathrm{~V}_{\text {OUT(T) }}=3.3 \mathrm{~V}, \mathrm{RL}=33 \Omega$
$\mathrm{C}_{\mathrm{IN}^{\prime}}=10 \mu \mathrm{~F}$ (GRM188D71A106MA73)
$\mathrm{C}_{\mathrm{L}}=30 \mu \mathrm{~F}(\mathrm{GRM} 188 \mathrm{D} 71 \mathrm{~A} 106 \mathrm{MA} 73 \times 3)$


XCL105B33 $\left(\mathrm{V}_{\mathrm{OUT}(\mathrm{T})}=3.3 \mathrm{~V}\right)$
$\mathrm{V}_{\text {IN }}=1.2 \mathrm{~V}, \mathrm{~V}_{\text {OUT(T) }}=3.3 \mathrm{~V}, \mathrm{RL}=33 \Omega$
$\mathrm{C}_{\mathrm{IN}}=10 \mu \mathrm{~F}$ (GRM188D71A106MA73)
$C_{L}=30 \mu \mathrm{~F}(\mathrm{GRM} 188 \mathrm{D} 71 \mathrm{~A} 106 \mathrm{MA} 73 \times 3)$


## TYPICAL PERFORMANCE CHARACTERISTICS

(29) Load Transient Response

## XCL104x18 ( $\mathrm{V}_{\text {OUT(T) }}=1.8 \mathrm{~V}$ )

$\mathrm{V}_{\text {IN }}=1.2 \mathrm{~V}, \mathrm{~V}_{\text {OUt(T) }}=1.8 \mathrm{~V}, \mathrm{l}_{\text {lut }}=10 \mathrm{~mA} \Leftrightarrow 100 \mathrm{~mA}(\mathrm{tr}=\mathrm{tf}=1 \mathrm{us})$ $\mathrm{C}_{\mathrm{IN}}=10 \mu \mathrm{~F}$ (GRM188D71A106MA73) $\mathrm{C}_{\mathrm{L}}=30 \mu \mathrm{~F}(\mathrm{GRM} 188 \mathrm{D} 71 \mathrm{~A} 106 \mathrm{MA} 73 \times 3)$


## XCL104x33 ( $\left.\mathrm{V}_{\text {OUT(T) }}=3.3 \mathrm{~V}\right)$

$\mathrm{V}_{\mathrm{IN}}=2.4 \mathrm{~V}, \mathrm{~V}_{\text {OUT(T) }}=3.3 \mathrm{~V}, \mathrm{I}_{\text {Out }}=50 \mathrm{~mA} \Leftrightarrow 300 \mathrm{~mA}(\mathrm{tr}=\mathrm{tf}=1 \mathrm{us})$ $\mathrm{C}_{\mathrm{N}}=10 \mu \mathrm{~F}$ (GRM188D71A106MA73) $\mathrm{C}_{\mathrm{L}}=30 \mu \mathrm{~F}(\mathrm{GRM} 188 \mathrm{D} 71 \mathrm{~A} 106 \mathrm{MA} 73 \times 3)$


XCL104x50 $\left(\mathrm{V}_{\text {OUT(T) }}=5.0 \mathrm{~V}\right)$
$\mathrm{V}_{\text {IN }}=3.7 \mathrm{~V}, \mathrm{~V}_{\text {OUT(T) }}=5.0 \mathrm{~V}, \mathrm{l}_{\text {Out }}=50 \mathrm{~mA} \Leftrightarrow 300 \mathrm{~mA}(\mathrm{tr}=\mathrm{ff}=1 \mathrm{us})$ $\mathrm{C}_{\mathrm{I}}=10 \mu \mathrm{~F}$ (GRM188D71A106MA73) $\mathrm{C}_{\mathrm{L}}=30 \mu \mathrm{~F}(\mathrm{GRM188D71A106MA73} \mathrm{\times 3)}$


XCL105x18 ( $\left.\mathrm{V}_{\text {OUT(T) }}=1.8 \mathrm{~V}\right)$
$\mathrm{V}_{\text {IN }}=1.2 \mathrm{~V}, \mathrm{~V}_{\text {OUT }(\mathrm{T})}=1.8 \mathrm{~V}, \mathrm{l}_{\text {out }}=10 \mathrm{~mA} \Leftrightarrow 100 \mathrm{~mA}(\mathrm{tr}=\mathrm{tf}=1 \mathrm{us})$ $\mathrm{C}_{\mathrm{N}}=10 \mu \mathrm{~F}$ (GRM188D71A106MA73) $G_{G}=30 \mu \mathrm{~F}(G R M 188 D 71$ A106MA73 $\times 3$ )


XCL105x33 ( $\mathrm{V}_{\text {OUT(T) }}=3.3 \mathrm{~V}$ )
$\mathrm{V}_{\text {IN }}=2.4 \mathrm{~V}, \mathrm{~V}_{\text {OUT(T) }}=3.3 \mathrm{~V}, \mathrm{l}_{\text {OUT }}=50 \mathrm{~mA} \Leftrightarrow 300 \mathrm{~mA}(\mathrm{tr}=\mathrm{tf}=1 \mathrm{us})$
$\mathrm{C}_{\mathrm{N}}=10 \mu \mathrm{~F}$ (GRM188D71A106MA73)
$\mathrm{C}_{\mathrm{L}}=30 \mu \mathrm{~F}(\mathrm{GRM} 188 \mathrm{D71A} 106 \mathrm{MA} 73 \times 3)$


## XCL105x50 ( $\left.\mathrm{V}_{\text {OUT(T) }}=5.0 \mathrm{~V}\right)$

$\mathrm{V}_{\text {IN }}=3.7 \mathrm{~V}, \mathrm{~V}_{\text {OUt(T) }}=5.0 \mathrm{~V}, \mathrm{I}_{\text {Out }}=50 \mathrm{~mA} \Leftrightarrow 300 \mathrm{~mA}(\mathrm{tr}=\mathrm{ff}=1 \mathrm{us})$
$\mathrm{C}_{\mathrm{N}}=10 \mu \mathrm{~F}$ (GRM188D71A106MA73)
$\mathrm{C}_{\mathrm{L}}=30 \mu \mathrm{~F}(\mathrm{GRM} 188 \mathrm{D71A} 106 \mathrm{MA} 73 \times 3)$


## PACKAGING INFORMATION

For the latest package information go to, www.torexsemi.com/technical-support/packages

| PACKAGE | OUTLINE / LAND PATTERN | THERMAL CHARACTERISTICS |
| :---: | :---: | :---: |
| DFN3030-10B | DFN3030-10B PKG | DFN3030-10B Power Dissipation |

## - MARKING RULE

■DFN3030-10B
MARK(1) represents product series and Oscillation Frequency

| MARK | PRODUCT NUMBER | TYPE | OUTPUT VOLTAGE RANGE | PRODUCT SERIES |
| :---: | :---: | :---: | :---: | :---: |
| 0 | XCL104 | A | $1.8 \sim 3.6 \mathrm{~V}$ | XCL104A181H2-G~XCL104A361H2-G |
| 1 |  |  | 3.7~5.5V | XCL104A371H2-G~XCL104A551H2-G |
| 2 |  | D | $2.2 \sim 3.6 \mathrm{~V}$ | XCL104D221H2-G~XCL104D361H2-G |
| 3 |  |  | 3.7~5.5V | XCL104D371H2-G~XCL104D551H2-G |
| C |  | G | $2.2 \sim 3.6 \mathrm{~V}$ | XCL104G221H2-G~XCL104G361H2-G |
| D |  |  | $3.7 \sim 5.5 \mathrm{~V}$ | XCL104G371H2-G~XCL104G551H2-G |
| E |  | J | $2.2 \sim 3.6 \mathrm{~V}$ | XCL104J221H2-G~XCL104J361H2-G |
| F |  |  | 3.7~5.5V | XCL104J371H2-G~XCL104J551H2-G |
| 4 | XCL105 | A | 1.8~3.6V | XCL105A181H2-G~XCL105A361H2-G |
| 5 |  |  | 3.7~5.5V | XCL105A371H2-G~XCL105A551H2-G |
| 6 |  | B | $1.8 \sim 3.6 \mathrm{~V}$ | XCL105B181H2-G~XCL105B361H2-G |
| 7 |  |  | $3.7 \sim 5.5 \mathrm{~V}$ | XCL105B371H2-G~XCL105B551H2-G |
| 8 |  | C | $1.8 \sim 3.6 \mathrm{~V}$ | XCL105C181H2-G~XCL105C361H2-G |
| 9 |  |  | $3.7 \sim 5.5 \mathrm{~V}$ | XCL105C371H2-G~XCL105C551H2-G |
| A |  | D | $2.2 \sim 3.6 \mathrm{~V}$ | XCL105D221H2-G~XCL105D361H2-G |
| B |  |  | $3.7 \sim 5.5 \mathrm{~V}$ | XCL105D371H2-G~XCL105D551H2-G |
| H |  | E | 2.2~3.6V | XCL105E221H2-G~XCL105E361H2-G |
| K |  |  | $3.7 \sim 5.5 \mathrm{~V}$ | XCL105E371H2-G~XCL105E551H2-G |
| L |  | F | 2.2~3.6V | XCL105F221H2-G~XCL105F361H2-G |
| M |  |  | $3.7 \sim 5.5 \mathrm{~V}$ | XCL105F371H2-G~XCL105F551H2-G |
| N |  | G | $2.2 \sim 3.6 \mathrm{~V}$ | XCL105G221H2-G~XCL105G361H2-G |
| P |  |  | 3.7~5.5V | XCL105G371H2-G~XCL105G551H2-G |
| R |  | H | $2.2 \sim 3.6 \mathrm{~V}$ | XCL105H221H2-G~XCL105H361H2-G |
| S |  |  | $3.7 \sim 5.5 \mathrm{~V}$ | XCL105H371H2-G~XCL105H551H2-G |
| T |  | M | $2.2 \sim 3.6 \mathrm{~V}$ | XCL105M221H2-G~XCL105M361H2-G |
| U |  |  | 3.7~5.5V | XCL105M371H2-G~XCL105M551H2-G |
| V |  | J | 2.2~3.6V | XCL105J221H2-G~XCL105J361H2-G |
| X |  |  | 3.7~5.5V | XCL105J371H2-G~XCL105J551H2-G |
| Y |  | K | 2.2~3.6V | XCL105K221H2-G~XCL105K361H2-G |
| Z |  |  | 3.7~5.5V | XCL105K371H2-G~XCL105K551H2-G |
| C |  | L | 2.2~3.0V | XCL105L221H2-G~XCL105L301H2-G |
| D |  |  | $3.1 \sim 3.9 \mathrm{~V}$ | XCL105L311H2-G~XCL105L391H2-G |
| E |  |  | $4.0 \sim 4.8 \mathrm{~V}$ | XCL105L401H2-G~XCL105L481H2-G |
| F |  |  | $4.9 \sim 5.5 \mathrm{~V}$ | XCL105L491H2-G~XCL105L551H2-G |

## XCL104/XCL105 Series

## MARKING RULE

MARK(2) represents output voltage
-XCL104, XCL105A/B/C/D/E/F/G/H/WJ/K

| MARK | OUTPUT VOLTAGE <br> RANGE |  | MARK | OUTPUT VOLTAGE <br> RANGE |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | 1.8 | 3.7 | A | 2.8 | 4.7 |
| 1 | 1.9 | 3.8 | B | 2.9 | 4.8 |
| 2 | 2.0 | 3.9 | C | 3.0 | 4.9 |
| 3 | 2.1 | 4.0 | D | 3.1 | 5.0 |
| 4 | 2.2 | 4.1 | E | 3.2 | 5.1 |
| 5 | 2.3 | 4.2 | F | 3.3 | 5.2 |
| 6 | 2.4 | 4.3 | H | 3.4 | 5.3 |
| 7 | 2.5 | 4.4 | K | 3.5 | 5.4 |
| 8 | 2.6 | 4.5 | L | 3.6 | 5.5 |
| 9 | 2.7 | 4.6 |  |  |  |

-XCL105L

| MARK | OUTPUT VOLTAGE RANGE |  |  |  |
| :---: | :---: | :---: | :---: | :---: |
| M | 2.2 | 3.1 | 4.0 | 4.9 |
| N | 2.3 | 3.2 | 4.1 | 5.0 |
| P | 2.4 | 3.3 | 4.2 | 5.1 |
| R | 2.5 | 3.4 | 4.3 | 5.2 |
| S | 2.6 | 3.5 | 4.4 | 5.3 |
| T | 2.7 | 3.6 | 4.5 | 5.4 |
| U | 2.8 | 3.7 | 4.6 | 5.5 |
| V | 2.9 | 3.8 | 4.7 |  |
| X | 3.0 | 3.9 | 4.8 |  |

MARK(3),(4) represents production lot number
01~09, 0A~0Z, 11~9Z, A1~A9, AA~AZ, B1~ZZ in order.
(G, I, J, O, Q, W excluded. No character inversion used.)

DFN3030-10B


1. The product and product specifications contained herein are subject to change without notice to improve performance characteristics. Consult us, or our representatives before use, to confirm that the information in this datasheet is up to date.
2. The information in this datasheet is intended to illustrate the operation and characteristics of our products. We neither make warranties or representations with respect to the accuracy or completeness of the information contained in this datasheet nor grant any license to any intellectual property rights of ours or any third party concerning with the information in this datasheet.
3. Applicable export control laws and regulations should be complied and the procedures required by such laws and regulations should also be followed, when the product or any information contained in this datasheet is exported.
4. The product is neither intended nor warranted for use in equipment of systems which require extremely high levels of quality and/or reliability and/or a malfunction or failure which may cause loss of human life, bodily injury, serious property damage including but not limited to devices or equipment used in 1) nuclear facilities, 2) aerospace industry, 3) medical facilities, 4) automobile industry and other transportation industry and 5) safety devices and safety equipment to control combustions and explosions. Do not use the product for the above use unless agreed by us in writing in advance.
5. Although we make continuous efforts to improve the quality and reliability of our products; nevertheless Semiconductors are likely to fail with a certain probability. So in order to prevent personal injury and/or property damage resulting from such failure, customers are required to incorporate adequate safety measures in their designs, such as system fail safes, redundancy and fire prevention features.
6. Our products are not designed to be Radiation-resistant.
7. Please use the product listed in this datasheet within the specified ranges.
8. We assume no responsibility for damage or loss due to abnormal use.
9. All rights reserved. No part of this datasheet may be copied or reproduced unless agreed by Torex Semiconductor Ltd in writing in advance.

[^0]:    <UVLO function: G/J/H/K/M/L types>
    $\mathrm{G} / \mathrm{H} / \mathrm{M} / \mathrm{J} / \mathrm{K} / \mathrm{L}$ types have UVLO function with UVLO release voltage of 1.6 V .
    This UVLO function stops the IC when the battery voltage drops.

[^1]:    < V $\operatorname{DD}$ MAX>
    $V_{D D}$ MAX circuit compares the input voltage and the output voltage then it will select the higher one as the power supply for the IC.

[^2]:    V : Output voltage after discharge
    Vout(T) : Target voltage
    t : Discharge time
    $\tau: \mathrm{CL}_{\llcorner } \times \mathrm{R}_{\mathrm{dch}}$
    $C_{L}$ : Capacitance of Output capacitor ( $\mathrm{C}_{\mathrm{L}}$ )
    Rdchg : Cl Discharge resistance, it depends on the Vin or Vout

